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# HN58V256A Series

# HN58V257A Series

32768-word × 8-bit Electrically Erasable and Programmable  
CMOS ROM

# HITACHI

ADE-203-357 A (Z)  
Rev. 1.0  
Apr. 12, 1996

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## Description

The Hitachi HN58V256A and HN58V257A are a electrically erasable and programmable EEPROM's organized as 32768-word × 8-bit. Employing advanced MNOS memory technology and CMOS process and circuitry technology. They also have a 64-byte page programming function to make their write operations faster.

## Features

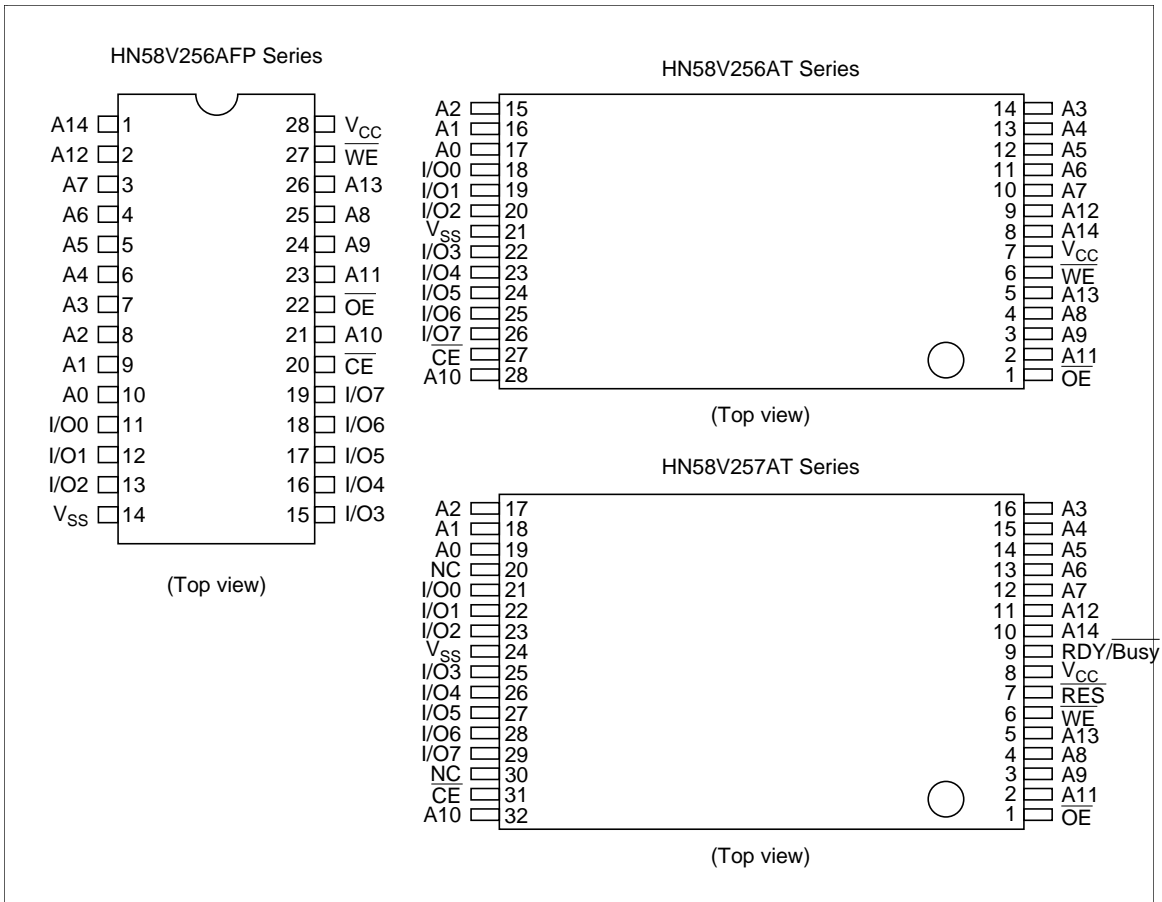
- Single 2.7 to 5.5 V supply
- On-chip latches: address, data,  $\overline{CE}$ ,  $\overline{OE}$ ,  $\overline{WE}$
- Automatic byte write: 10 ms max
- Automatic page write (64 bytes): 10 ms max
- Fast access time: 120 ns max
- Low power dissipation: active: 20 mW/MHz, (typ)  
standby: 110  $\mu$ W (max)
- Ready/ $\overline{Busy}$  (only the HN58V267A series)
- $\overline{Data}$  polling and Toggle bit
- Data protection circuit on power on/off
- Conforms to JEDEC byte-wide standard
- Reliable CMOS with MNOS cell technology
- $10^5$  erase/write cycles (in page mode)
- 10 years data retention
- Software data protection
- Write protection by  $\overline{RES}$  pin (only the HN58V267A series)
- Industrial versions (Temperatur range:  $-20$  to  $85^\circ\text{C}$  and  $-40$  to  $85^\circ\text{C}$ ) are also available.

# HN58V256A Series, HN58V257A Series

## Ordering Information

Type No.	Access time	Package
HN58V256AFP-12	120 ns	400 mil 28-pin plastic SOP (FP-28D)
HN58V256AT-12	120 ns	28-pin plastic TSOP (TFP-28DB)
HN58V257AT-12	120 ns	8 × 14 mm 32-pin plastic TSOP (TFP-32DA)

## Pin Arrangement



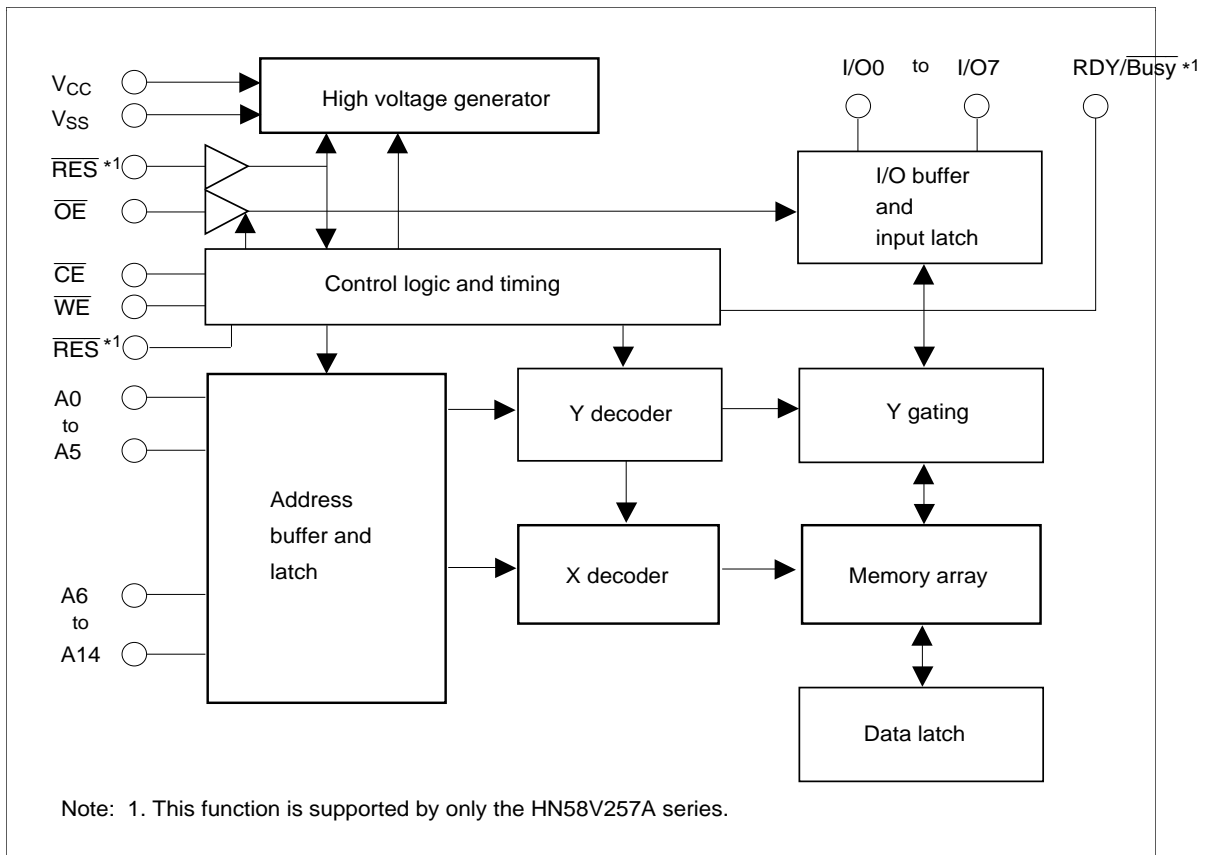
## HN58V256A Series, HN58V257A Series

### Pin Description

Pin name	Function
A0 to A14	Address input
I/O0 to I/O7	Data input/output
$\overline{OE}$	Output enable
$\overline{CE}$	Chip enable
$\overline{WE}$	Write enable
$V_{CC}$	Power supply
$V_{SS}$	Ground
RDY/Busy* <sup>1</sup>	Ready busy
$\overline{RES}^{*1}$	Reset
NC	No connection

Note: 1. This function is supported by only the HN58V257A series.

### Block Diagram



## HN58V256A Series, HN58V257A Series

### Mode Selection

Pin mode	$\overline{CE}$	$\overline{OE}$	$\overline{WE}$	$\overline{RES}^{*3}$	$RDY/\overline{Busy}^{*3}$	I/O
Read	$V_{IL}$	$V_{IL}$	$V_{IH}$	$V_H^{*1}$	High-Z	Dout
Standby	$V_{IH}$	$\times^{*2}$	$\times$	$\times$	High-Z	High-Z
Write	$V_{IL}$	$V_{IH}$	$V_{IL}$	$V_H$	High-Z to $V_{OL}$	Din
Deselect	$V_{IL}$	$V_{IH}$	$V_{IH}$	$V_H$	High-Z	High-Z
Write inhibit	$\times$	$\times$	$V_{IH}$	$\times$	—	—
	$\times$	$V_{IL}$	$\times$	$\times$	—	—
Data polling	$V_{IL}$	$V_{IL}$	$V_{IH}$	$V_H$	$V_{OL}$	Data out (I/O7)
Program reset	$\times$	$\times$	$\times$	$V_{IL}$	High-Z	High-Z

- Notes: 1. Refer to the recommended DC operating condition.  
 2.  $\times$  = Don't care  
 3. This function is supported by only the HN58V267A series.

### Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Supply voltage <sup>*1</sup>	$V_{CC}$	-0.6 to +7.0	V
Input voltage <sup>*1</sup>	$V_{in}$	-0.5 <sup>*2</sup> to +7.0 <sup>*4</sup>	V
Operating temperature range <sup>*3</sup>	$T_{opr}$	0 to +70	°C
Storage temperature range	$T_{stg}$	-55 to +125	°C

- Notes: 1. With respect to  $V_{SS}$   
 2.  $V_{in\ min} = -3.0\ V$  for pulse width  $\leq 50\ ns$   
 3. Including electrical characteristics and data retention  
 4. Should not exceed  $V_{CC} + 1\ V$ .

## HN58V256A Series, HN58V257A Series

### Recommended DC Operating Conditions

Parameter	Symbol	Min	Typ	Max	Unit
Supply voltage	$V_{CC}$	2.7	3.0	5.5	V
Input voltage	$V_{IL}$	-0.3 <sup>1</sup>	—	0.6	V
	$V_{IH}$	1.9 <sup>2</sup>	—	$V_{CC} + 0.3$ <sup>3</sup>	V
	$V_H$ <sup>4</sup>	$V_{CC} - 0.5$	—	$V_{CC} + 1.0$	V
Operating temperature	Topr	0	—	70	°C

- Notes: 1.  $V_{IL}$  min: -1.0 V for pulse width  $\leq 50$  ns.  
 2.  $V_{IH}$  min for  $V_{CC} = 3.6$  to 5.5 V is 2.4 V.  
 3.  $V_{IH}$  max:  $V_{CC} + 1.0$  V for pulse width  $\leq 50$  ns.  
 4. This function is supported by only the HN58V257A series.

### DC Characteristics (Ta = 0 to +70°C, $V_{CC} = 2.7$ to 5.5 V)

Parameter	Symbol	Min	Typ	Max	Unit	Test conditions
Input leakage current	$I_{LI}$	—	—	2 <sup>1</sup>	$\mu A$	$V_{CC} = 5.5$ V, $V_{in} = 5.5$ V
Output leakage current	$I_{LO}$	—	—	2	$\mu A$	$V_{CC} = 5.5$ V, $V_{out} = 5.5/0.4$ V
$V_{CC}$ current (standby)	$I_{CC1}$	—	—	20	$\mu A$	$\overline{CE} = V_{CC}$
	$I_{CC2}$	—	—	1	mA	$\overline{CE} = V_{IH}$
$V_{CC}$ current (active)	$I_{CC3}$	—	—	8	mA	$I_{out} = 0$ mA, Duty = 100%, Cycle = 1 $\mu s$ at $V_{CC} = 3.6$ V
	—	—	—	12	mA	$I_{out} = 0$ mA, Duty = 100%, Cycle = 1 $\mu s$ at $V_{CC} = 5.5$ V
	—	—	—	12	mA	$I_{out} = 0$ mA, Duty = 100%, Cycle = 120 ns at $V_{CC} = 3.6$ V
	—	—	—	30	mA	$I_{out} = 0$ mA, Duty = 100%, Cycle = 120 ns at $V_{CC} = 5.5$ V
Output low voltage	$V_{OL}$	—	—	0.4	V	$I_{OL} = 2.1$ mA
Output high voltage	$V_{OH}$	$V_{CC} \times 0.8$	—	—	V	$I_{OH} = -400$ $\mu A$

Note: 1.  $I_{LI}$  on  $\overline{RES} = 100$   $\mu A$  max (only the HN58V257A series)

### Capacitance (Ta = 25°C, f = 1 MHz)

Parameter	Symbol	Min	Typ	Max	Unit	Test conditions
Input capacitance <sup>*1</sup>	$C_{in}$	—	—	6	pF	$V_{in} = 0$ V
Output capacitance <sup>*1</sup>	$C_{out}$	—	—	12	pF	$V_{out} = 0$ V

Note: 1. This parameter is periodically sampled and not 100% tested.

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### AC Characteristics (Ta = 0 to +70°C, V<sub>CC</sub> = 2.7 to 5.5 V)

#### Test Conditions

- Input pulse levels: 0.4 V to 2.4 V (V<sub>CC</sub> ≤ 3.6V), 0.4V to 3.0 V (V<sub>CC</sub> > 3.6 V)  
0 V to V<sub>CC</sub> ( $\overline{\text{RES}}$  pin\*<sup>2</sup>)
- Input rise and fall time: ≤ 5 ns
- Input timing reference levels: 0.8, 1.8 V
- Output load: 1TTL Gate +100 pF
- Output reference levels: 1.5 V, 1.5 V

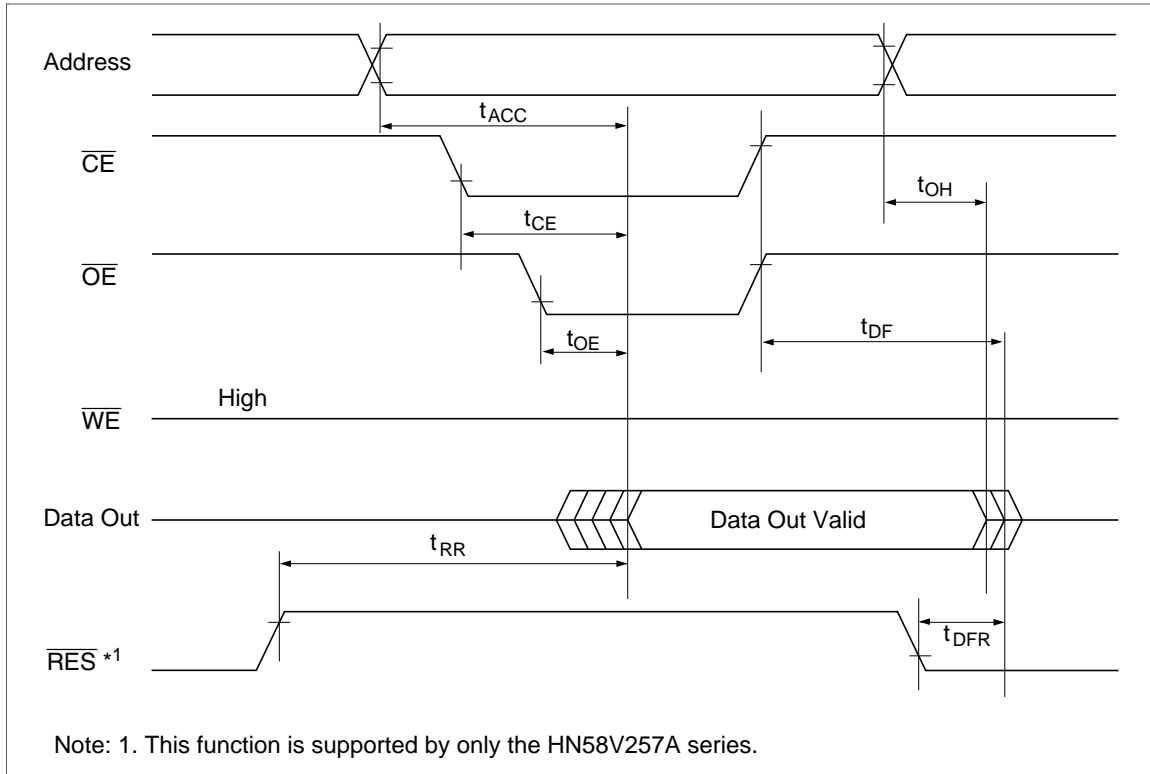
#### Read Cycle

HN58V256A/HN58V257A					
-12					
Parameter	Symbol	Min	Max	Unit	Test conditions
Address to output delay	t <sub>ACC</sub>	—	120	ns	$\overline{\text{CE}} = \overline{\text{OE}} = V_{\text{IL}}, \overline{\text{WE}} = V_{\text{IH}}$
$\overline{\text{CE}}$ to output delay	t <sub>CE</sub>	—	120	ns	$\overline{\text{OE}} = V_{\text{IL}}, \overline{\text{WE}} = V_{\text{IH}}$
$\overline{\text{OE}}$ to output delay	t <sub>OE</sub>	10	60	ns	$\overline{\text{CE}} = V_{\text{IL}}, \overline{\text{WE}} = V_{\text{IH}}$
Address to output hold	t <sub>OH</sub>	0	—	ns	$\overline{\text{CE}} = \overline{\text{OE}} = V_{\text{IL}}, \overline{\text{WE}} = V_{\text{IH}}$
$\overline{\text{OE}}$ ( $\overline{\text{CE}}$ ) high to output float* <sup>1</sup>	t <sub>DF</sub>	0	40	ns	$\overline{\text{CE}} = V_{\text{IL}}, \overline{\text{WE}} = V_{\text{IH}}$
$\overline{\text{RES}}$ low to output float* <sup>1, 2</sup>	t <sub>DFR</sub>	0	350	ns	$\overline{\text{CE}} = \overline{\text{OE}} = V_{\text{IL}}, \overline{\text{WE}} = V_{\text{IH}}$
$\overline{\text{RES}}$ to output delay* <sup>2</sup>	t <sub>RR</sub>	0	600	ns	$\overline{\text{CE}} = \overline{\text{OE}} = V_{\text{IL}}, \overline{\text{WE}} = V_{\text{IH}}$

- Notes: 1. t<sub>DF</sub> and t<sub>DFR</sub> are defined as the time at which the outputs achieve the open circuit conditions and are no longer driven.
2. This function is supported by only the HN58V267A series.

## HN58V256A Series, HN58V257A Series

### Read Timing Waveform



## HN58V256A Series, HN58V257A Series

### Write Cycle

Parameter	Symbol	Min* <sup>1</sup>	Typ	Max	Unit	Test conditions
Address setup time	$t_{AS}$	0	—	—	ns	
Address hold time	$t_{AH}$	50	—	—	ns	
$\overline{CE}$ to write setup time ( $\overline{WE}$ controlled)	$t_{CS}$	0	—	—	ns	
$\overline{CE}$ hold time ( $\overline{WE}$ controlled)	$t_{CH}$	0	—	—	ns	
$\overline{WE}$ to write setup time ( $\overline{CE}$ controlled)	$t_{WS}$	0	—	—	ns	
$\overline{WE}$ hold time ( $\overline{CE}$ controlled)	$t_{WH}$	0	—	—	ns	
$\overline{OE}$ to write setup time	$t_{OES}$	0	—	—	ns	
$\overline{OE}$ hold time	$t_{OEH}$	0	—	—	ns	
Data setup time	$t_{DS}$	70	—	—	ns	
Data hold time	$t_{DH}$	0	—	—	ns	
$\overline{WE}$ pulse width ( $\overline{WE}$ controlled)	$t_{WP}$	200	—	—	ns	
$\overline{CE}$ pulse width ( $\overline{CE}$ controlled)	$t_{CW}$	200	—	—	ns	
Data latch time	$t_{DL}$	100	—	—	ns	
Byte load cycle	$t_{BLC}$	0.3	—	30	$\mu$ s	
Byte load window	$t_{BL}$	100	—	—	$\mu$ s	
Write cycle time	$t_{WC}$	—	—	$10^{*2}$	ms	
Time to device busy	$t_{DB}$	120	—	—	ns	
Write start time	$t_{DW}$	$0^{*3}$	—	—	ns	
Reset protect time* <sup>4</sup>	$t_{RP}$	100	—	—	$\mu$ s	
Reset high time* <sup>4, 5</sup>	$t_{RES}$	1	—	—	$\mu$ s	

Notes: 1. Use this device in longer cycle than this value.

2.  $t_{WC}$  must be longer than this value unless polling techniques or  $RDY/\overline{Busy}$  (only the HN58V257A series) are used. This device automatically completes the internal write operation within this value.

3. Next read or write operation can be initiated after  $t_{DW}$  if polling techniques or  $RDY/\overline{Busy}$  (only the HN58V257A series) are used.

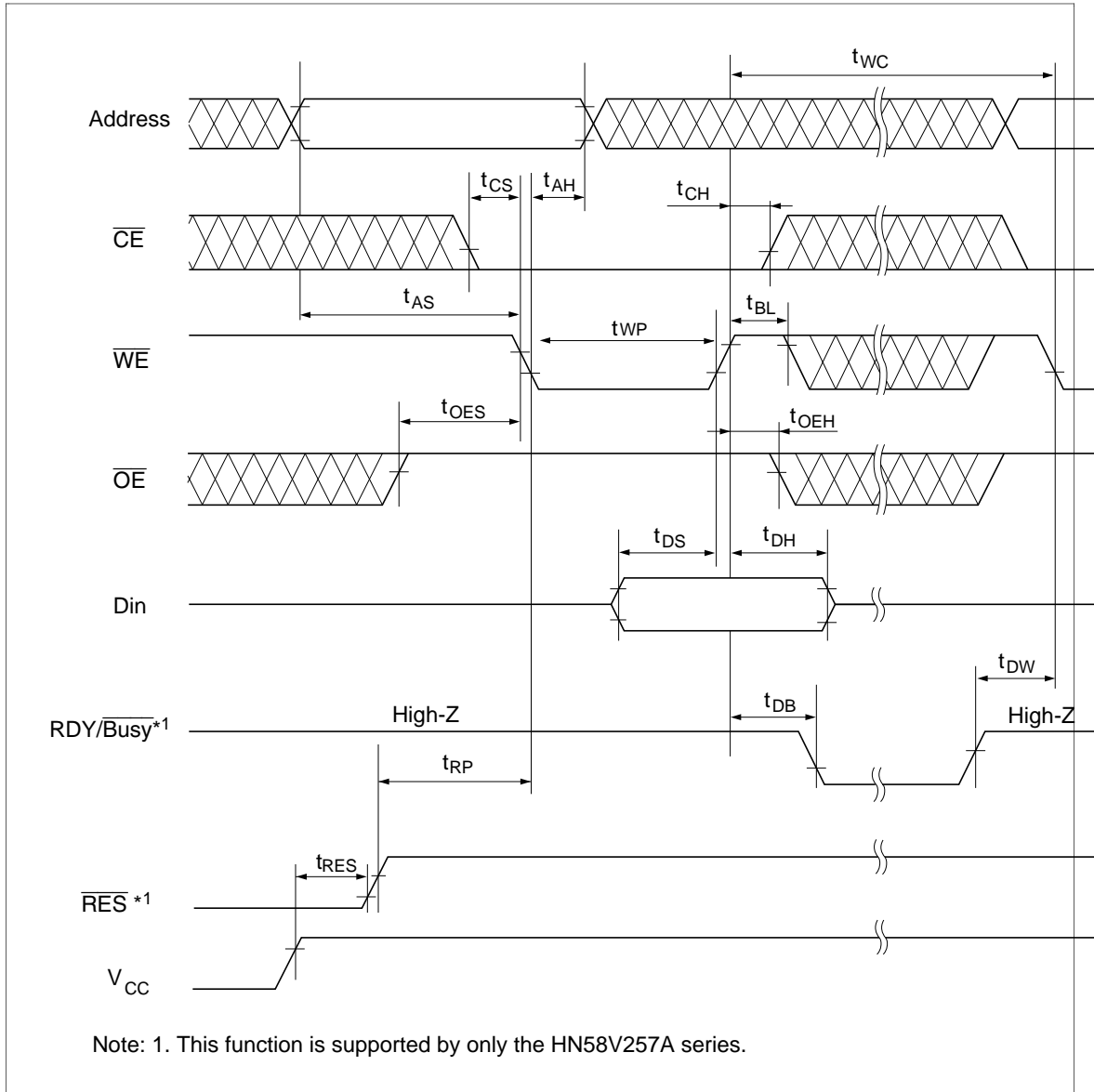
4. This function is supported by only the HN58V257A series.

5. This parameter is sampled and not 100% tested.



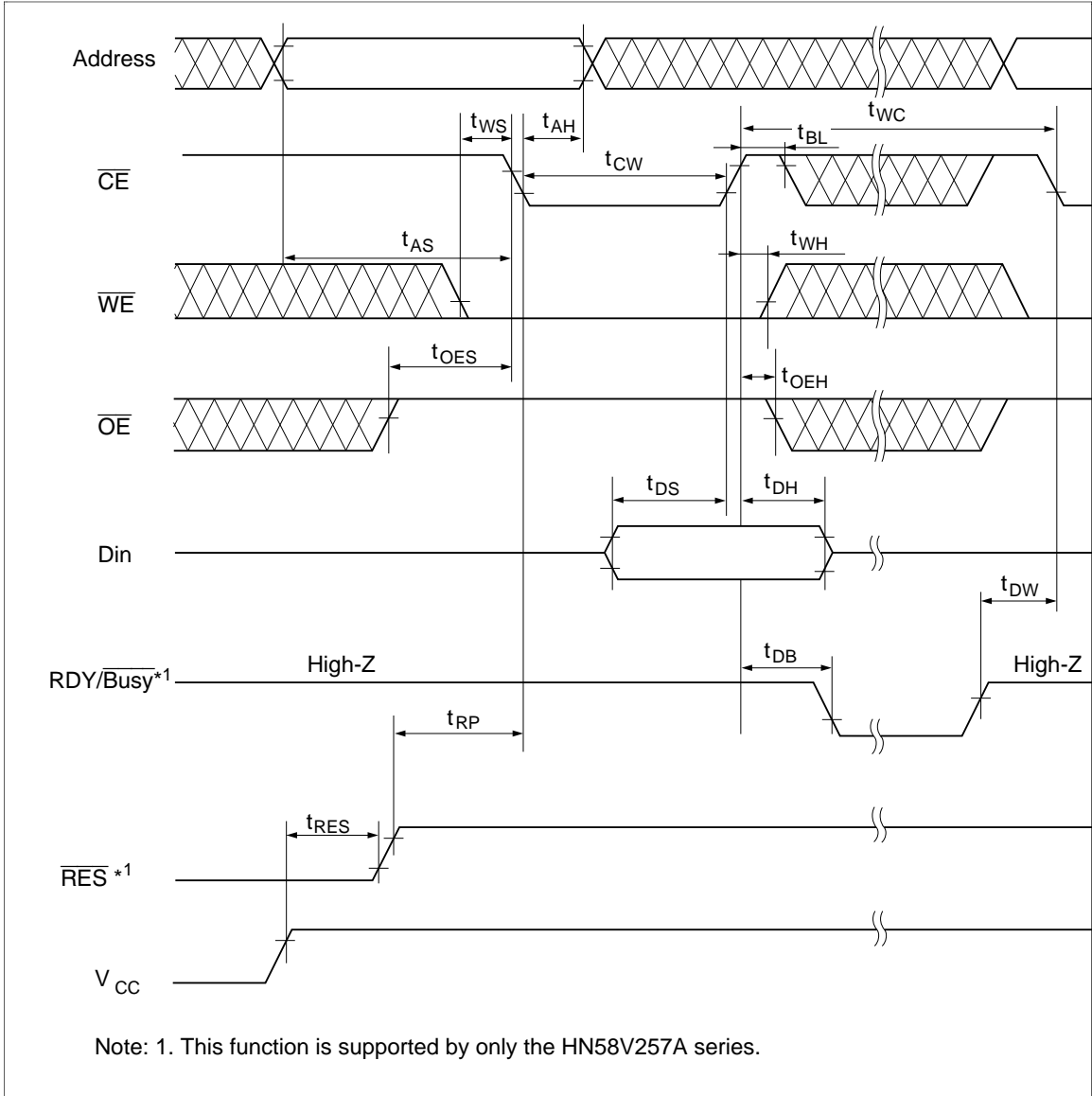
## HN58V256A Series, HN58V257A Series

**Byte Write Timing Waveform (1) ( $\overline{\text{WE}}$  Controlled)**



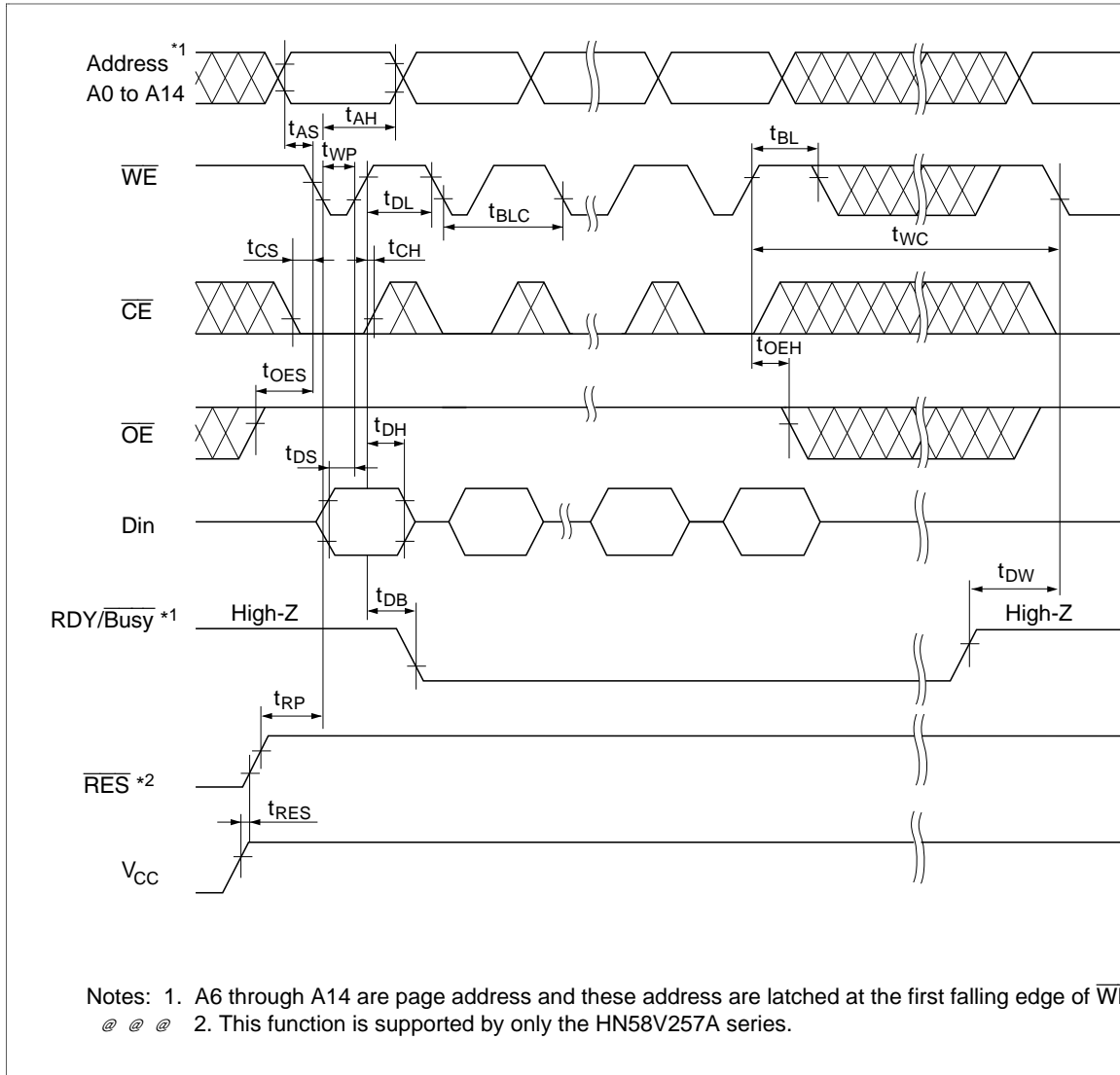
## HN58V256A Series, HN58V257A Series

Byte Write Timing Waveform (2) ( $\overline{CE}$  Controlled)



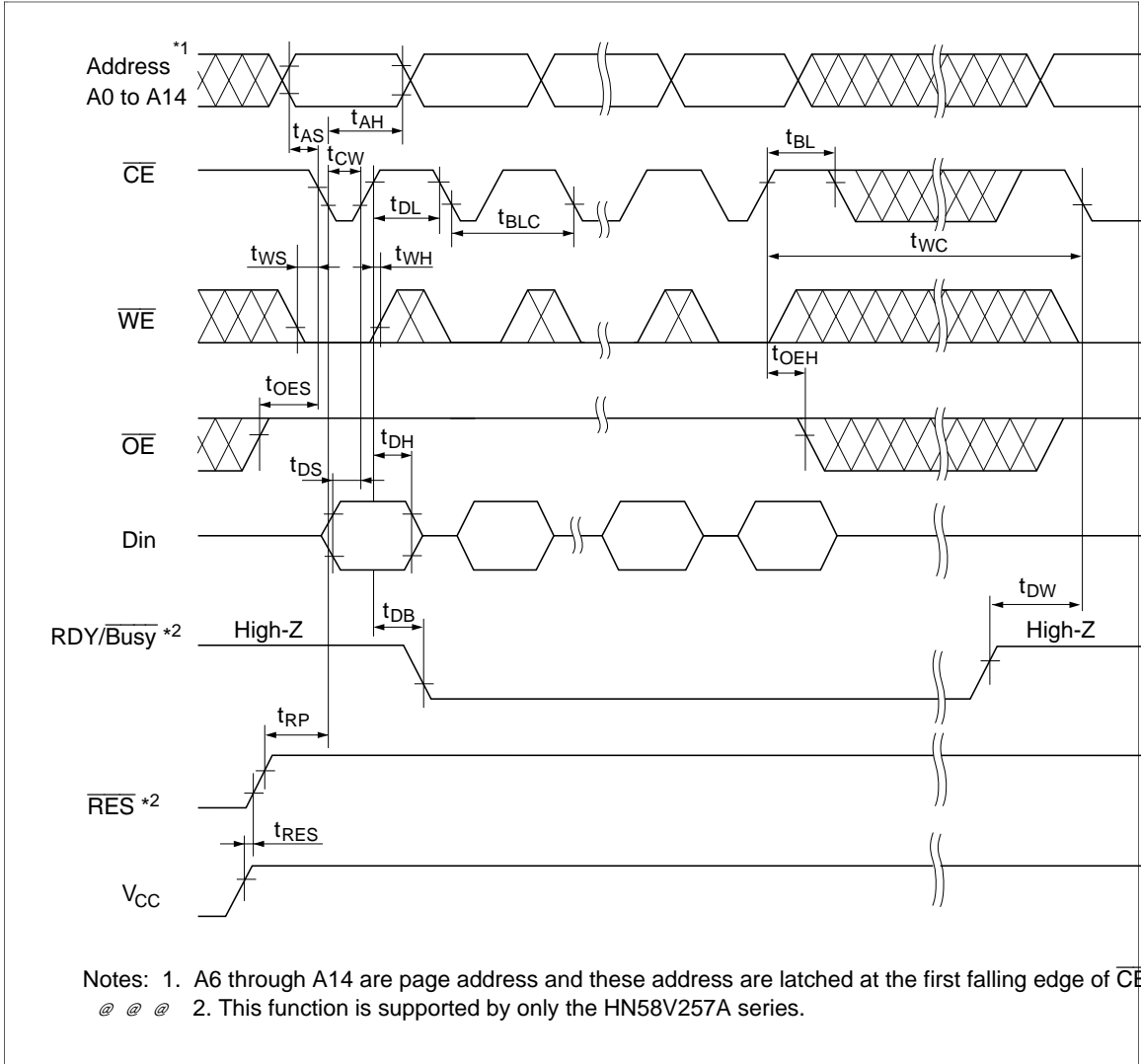
## HN58V256A Series, HN58V257A Series

### Page Write Timing Waveform (1) ( $\overline{WE}$ Controlled)



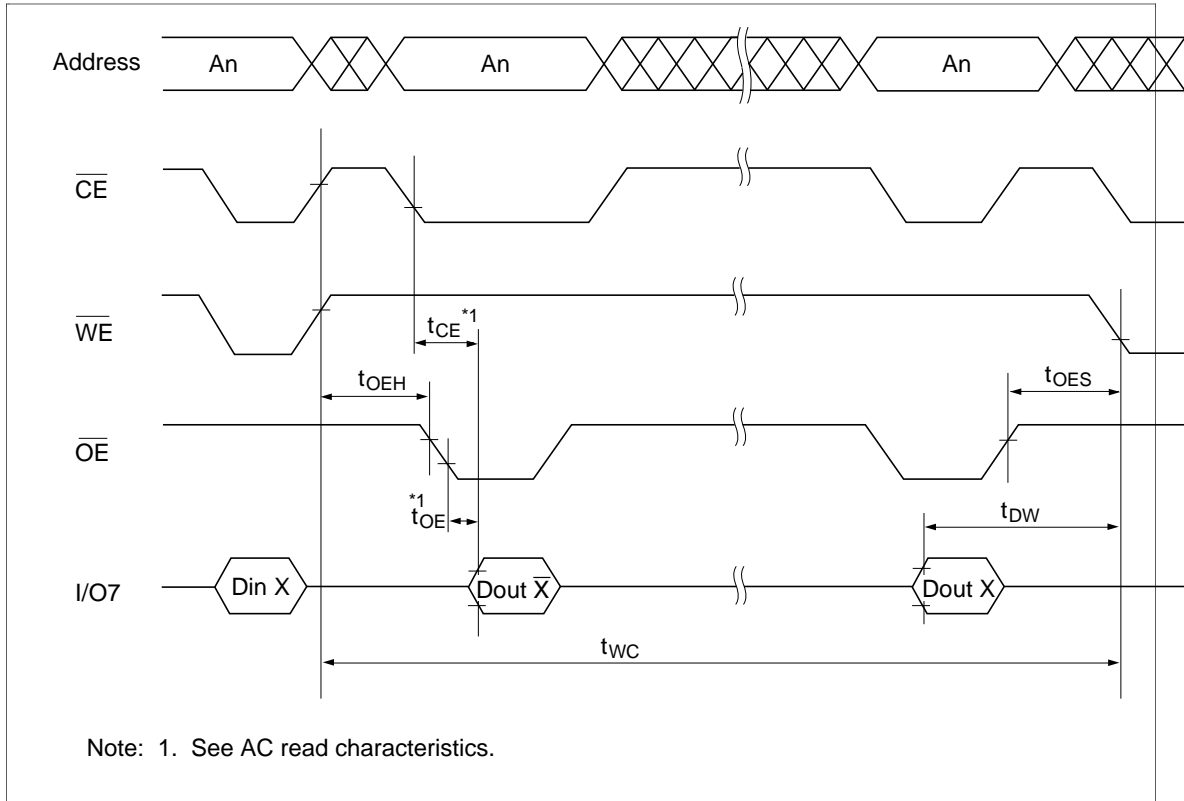
# HN58V256A Series, HN58V257A Series

## Page Write Timing Waveform (2) ( $\overline{CE}$ Controlled)



## HN58V256A Series, HN58V257A Series

### Data Polling Timing Waveform



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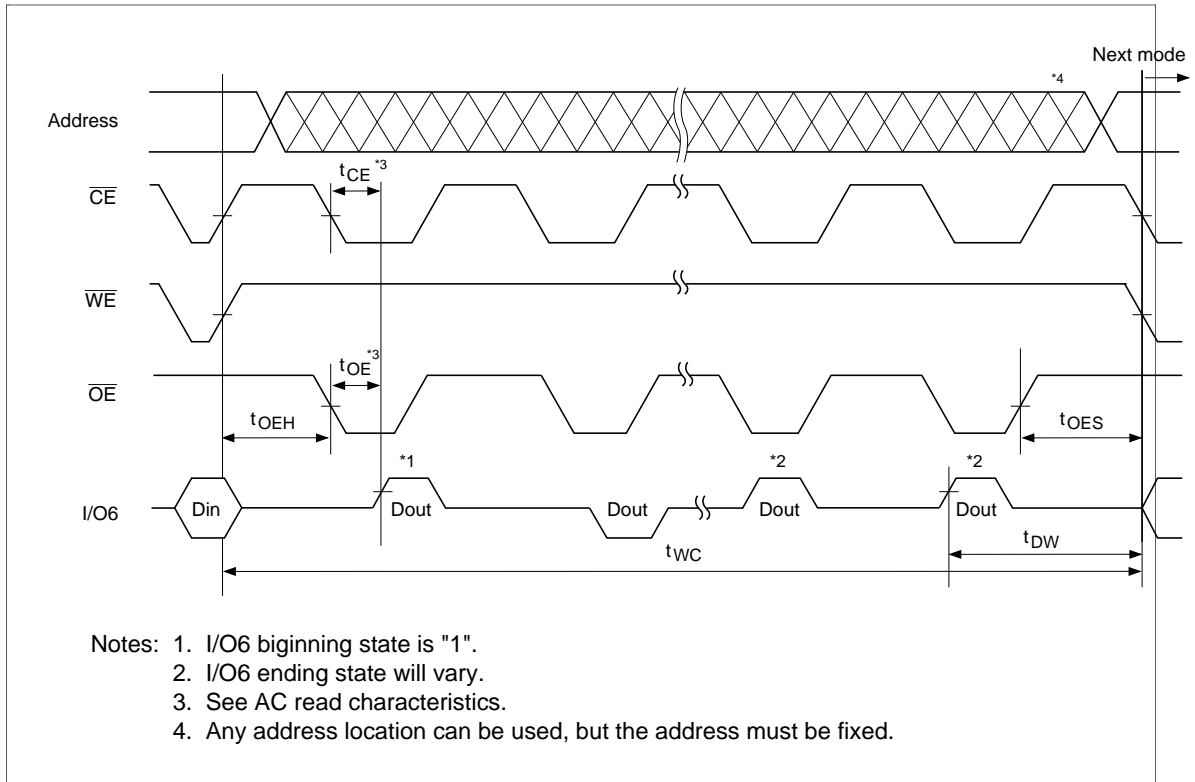
## HN58V256A Series, HN58V257A Series

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### Toggle bit

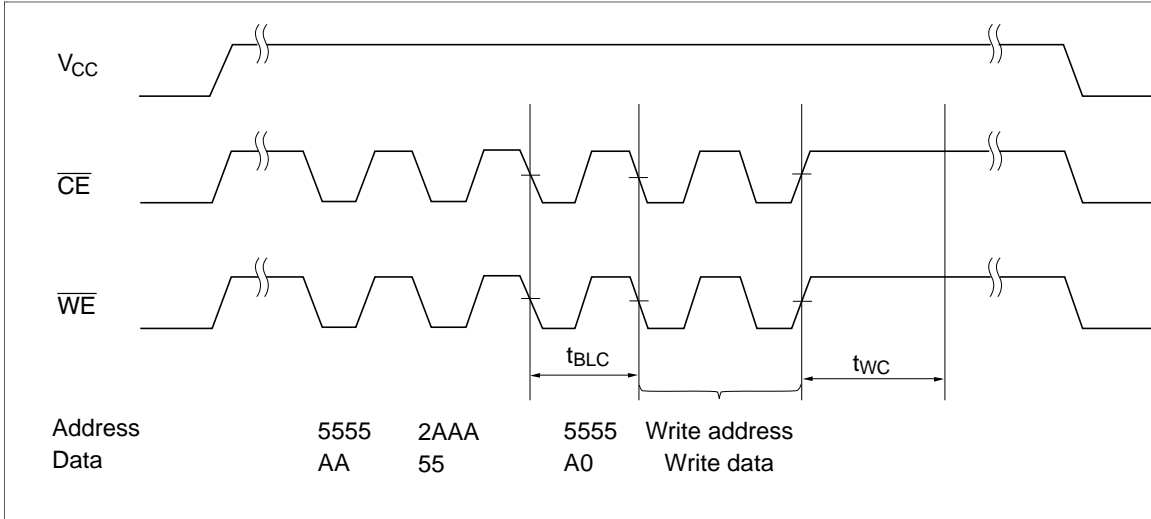
This device provide another function to determine the internal programming cycle. If the EEPROM is set to read mode during the internal programming cycle, I/O6 will charge from "1" to "0" (togglng) for each read. When the internal programming cycle is finished, togglng of I/O6 will stop and the device can be accessible for next read or program.

### Toggle bit Waveform

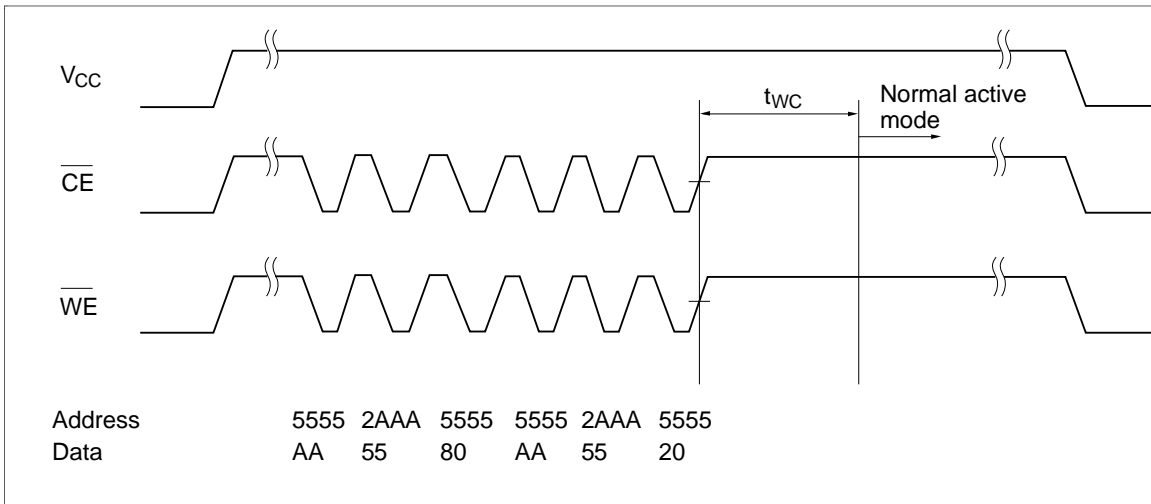


## HN58V256A Series, HN58V257A Series

**Software Data Protection Timing Waveform (1) (in protection mode)**



**Software Data Protection Timing Waveform (2) (in non-protection mode)**



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## HN58V256A Series, HN58V257A Series

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### Functional Description

#### Automatic Page Write

Page-mode write feature allows 1 to 64 bytes of data to be written into the EEPROM in a single write cycle. Following the initial byte cycle, an additional 1 to 63 bytes can be written in the same manner. Each additional byte load cycle must be started within 30  $\mu\text{s}$  from the preceding falling edge of  $\overline{\text{WE}}$  or  $\overline{\text{CE}}$ . When  $\overline{\text{CE}}$  or  $\overline{\text{WE}}$  is high for 100  $\mu\text{s}$  after data input, the EEPROM enters write mode automatically and the input data are written into the EEPROM.

#### Data Polling

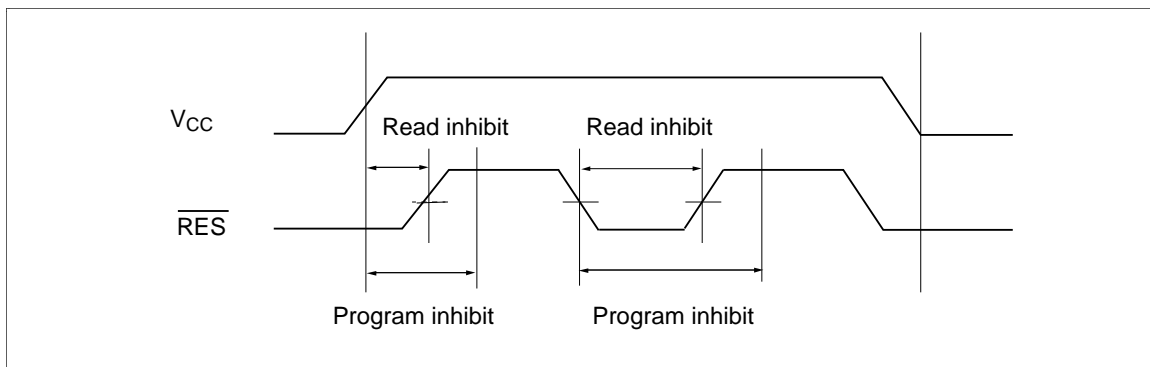
Data polling allows the status of the EEPROM to be determined. If EEPROM is set to read mode during a write cycle, an inversion of the last byte of data to be loaded outputs from I/O7 to indicate that the EEPROM is performing a write operation.

#### RDY/ $\overline{\text{Busy}}$ Signal (only the HN58V257A series)

RDY/ $\overline{\text{Busy}}$  signal also allows the status of the EEPROM to be determined. The RDY/ $\overline{\text{Busy}}$  signal has high impedance except in write cycle and is lowered to  $V_{\text{OL}}$  after the first write signal. At the end of a write cycle, the RDY/ $\overline{\text{Busy}}$  signal changes state to high impedance.

#### $\overline{\text{RES}}$ Signal (only the HN58V257A series)

When  $\overline{\text{RES}}$  is low, the EEPROM cannot be read or programmed. Therefore, data can be protected by keeping  $\overline{\text{RES}}$  low when  $V_{\text{CC}}$  is switched.  $\overline{\text{RES}}$  should be high during read and programming because it doesn't provide a latch function.





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## HN58V256A Series, HN58V257A Series

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### $\overline{\text{WE}}$ , $\overline{\text{CE}}$ Pin Operation

During a write cycle, addresses are latched by the falling edge of  $\overline{\text{WE}}$  or  $\overline{\text{CE}}$ , and data is latched by the rising edge of  $\overline{\text{WE}}$  or  $\overline{\text{CE}}$ .

### Write/Erase Endurance and Data Retention Time

The endurance is  $10^5$  cycles in case of the page programming and  $10^4$  cycles in case of the byte programming (1% cumulative failure rate). The data retention time is more than 10 years when a device is page-programmed less than  $10^4$  cycles.

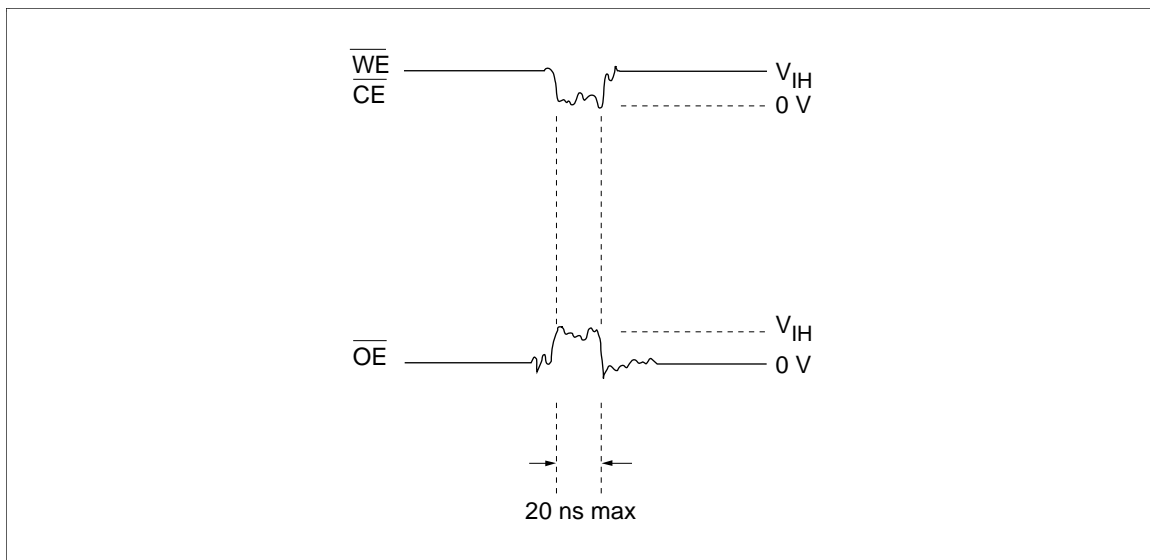
### Data Protection

#### 1. Data Protection against Noise on Control Pins ( $\overline{\text{CE}}$ , $\overline{\text{OE}}$ , $\overline{\text{WE}}$ ) during Operation

During readout or standby, noise on the control pins may act as a trigger and turn the EEPROM to programming mode by mistake.

To prevent this phenomenon, this device has a noise cancelation function that cuts noise if its width is 20 ns or less in program mode.

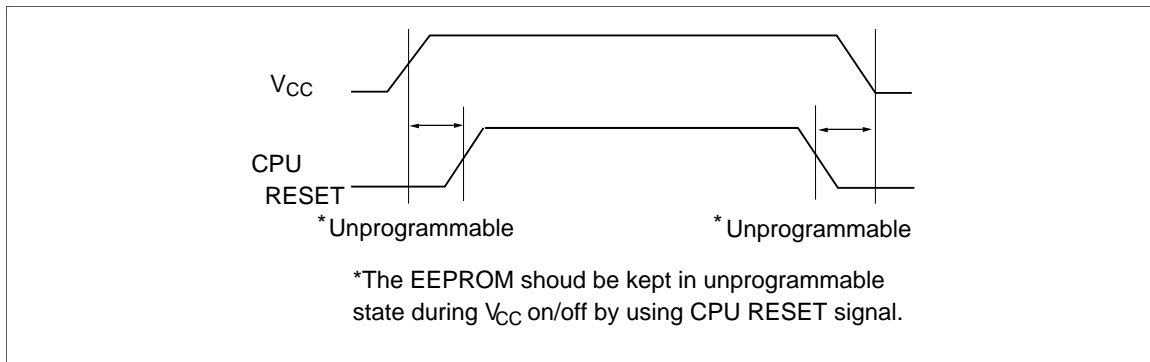
Be careful not to allow noise of a width of more than 20 ns on the control pins.



## HN58V256A Series, HN58V257A Series

### 2. Data Protection at $V_{CC}$ On/Off

When  $V_{CC}$  is turned on or off, noise on the control pins generated by external circuits (CPU, etc) may act as a trigger and turn the EEPROM to program mode by mistake. To prevent this unintentional programming, the EEPROM must be kept in an unprogrammable state while the CPU is in an unstable state.



#### (1) Protection by $\overline{CE}$ , $\overline{OE}$ , $\overline{WE}$

To realize the unprogrammable state, the input level of control pins must be held as shown in the table below.

$\overline{CE}$	$V_{CC}$	×	×
$\overline{OE}$	×	$V_{SS}$	×
$\overline{WE}$	×	×	$V_{CC}$

×: Don't care.

$V_{CC}$ : Pull-up to  $V_{CC}$  level.

$V_{SS}$ : Pull-down to  $V_{SS}$  level.

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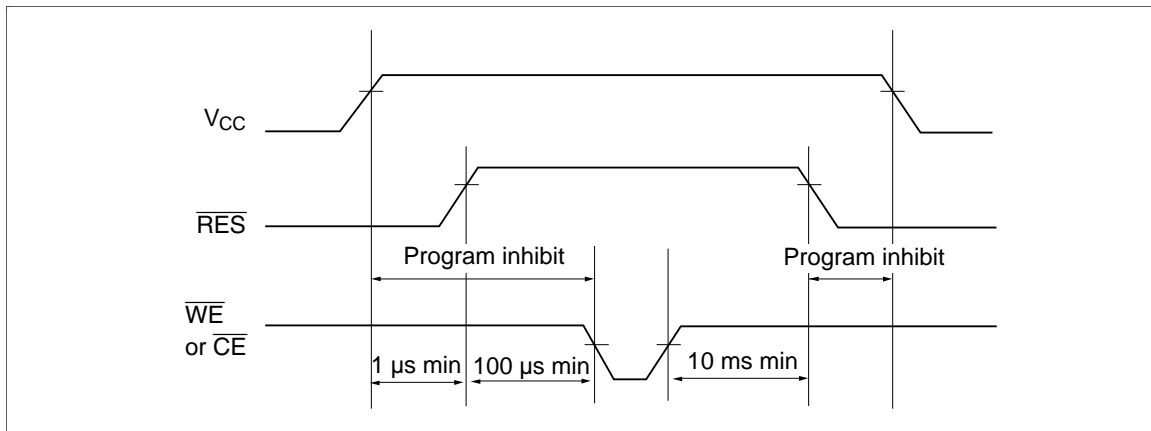
## HN58V256A Series, HN58V257A Series

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(2) Protection by  $\overline{\text{RES}}$  (only the HN58V257A series)

The unprogrammable state can be realized by that the CPU's reset signal inputs directly to the EEPROM's  $\overline{\text{RES}}$  pin.  $\overline{\text{RES}}$  should be kept  $V_{\text{SS}}$  level during  $V_{\text{CC}}$  on/off.

The EEPROM breaks off programming operation when  $\overline{\text{RES}}$  becomes low, programming operation doesn't finish correctly in case that  $\overline{\text{RES}}$  falls low during programming operation.  $\overline{\text{RES}}$  should be kept high for 10 ms after the last data input.



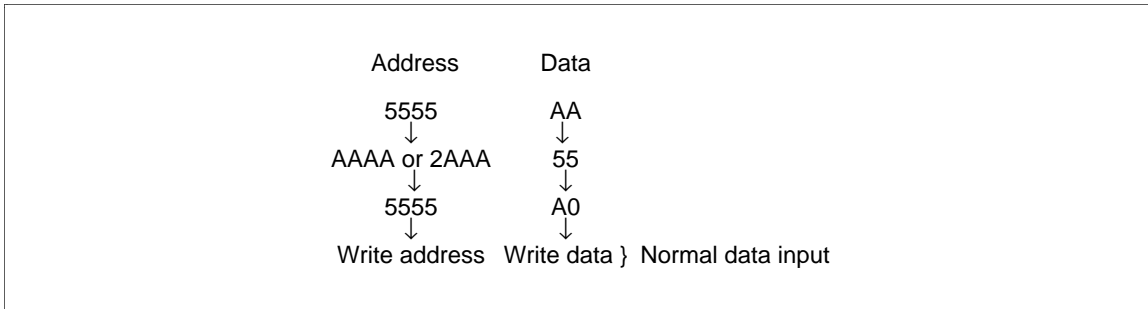
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## HN58V256A Series, HN58V257A Series

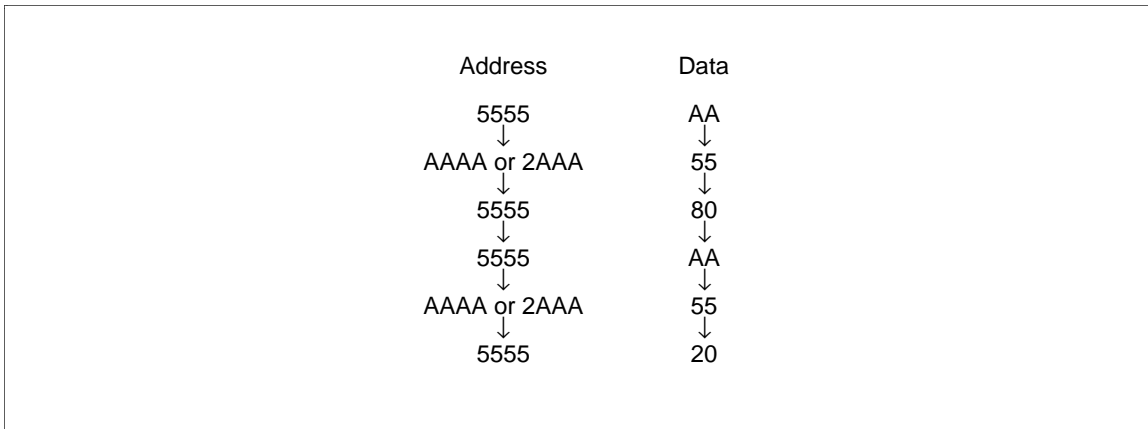
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### 3. Software data protection

To prevent unintentional programming caused by noise generated by external circuits. This device has the software data protection function. In software data protection mode, 3 bytes of data must be input before write data as follows. And these bytes can switch the non-protection mode to the protection mode.



Software data protection mode can be cancelled by inputting the following 6 bytes. After that, this device turns to the non-protection mode and can write data normally. But when the data is input in the cancelling cycle, the data cannot be written.



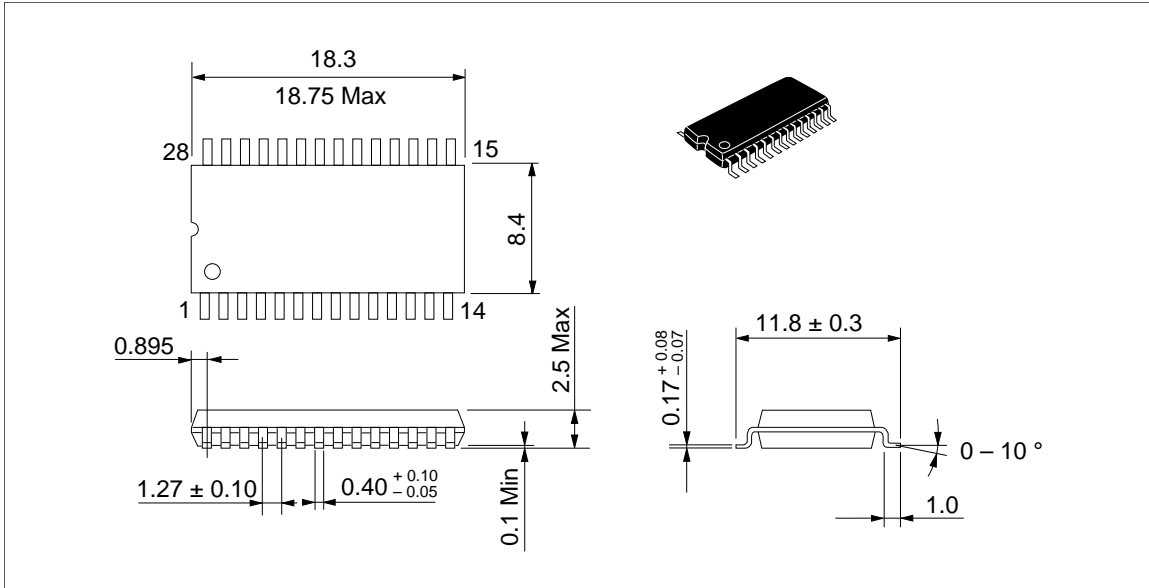
The software data protection is not enabled at the shipment.

# HN58V256A Series, HN58V257A Series

## Package Dimensions

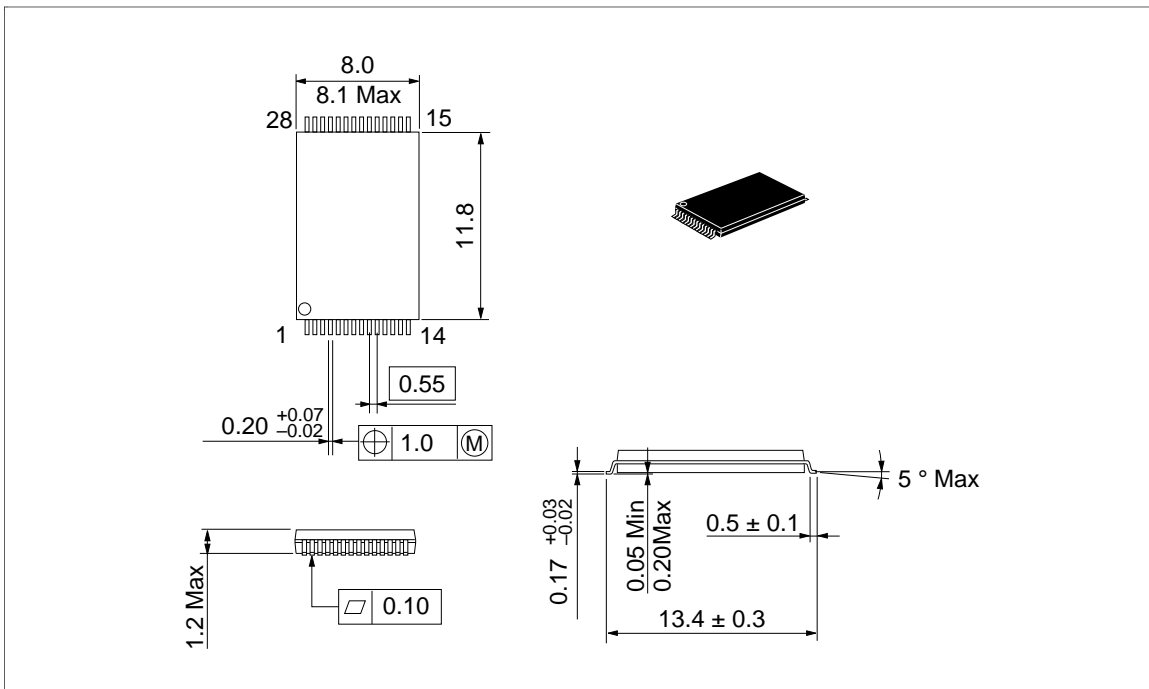
HN58V256AFP Series (FP-28D)

Unit: mm



HN58V256AT Series (TFP-28DB)

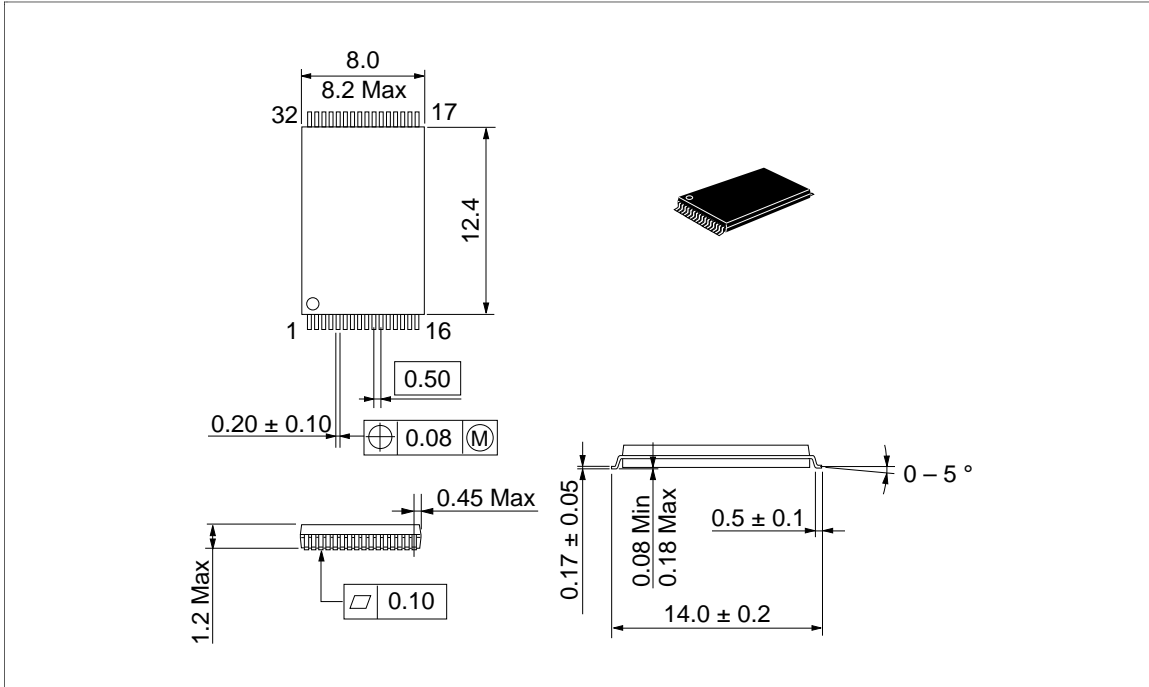
Unit: mm



# HN58V256A Series, HN58V257A Series

HN58V257AT Series (TFP-32DA)

Unit: mm



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## HN58V256A Series, HN58V257A Series

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## HN58V256A Series, HN58V257A Series

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### Revision Record

Rev.	Date	Contents of Modification	Drawn by	Approved by
0.0	Mar. 15, 1995	Initial issue	M. Terasawa	T. Muto
0.1	Aug. 7, 1995	Determination of package type: HN58V256AT series (TFP-28DB) Deletion of HN58V256AP series (DP-28) Deletion of HN58V256AFPI-12/15 Deletion of HN58V256AT-12SR/15SR Deletion of HN58V257AT-12SR/15SR Absolute Maximum Rating Deletion of Device Group Deletion of Operating temperature range – 20 to + 85°C and – 40 to +85°C Recommended DC Operating Conditions Deletion of Device Group Deletion of Operating temperature range –20/—/85°C and –40/—/85°C Deletion of note 4 Change order of notes	M. Terasawa	T. Muto
1.0	Apr. 12, 1995	Change of format Opelating Information Deletion of HN58V256A-15 and HN58V257A-15 Deletion of note 1 Deletion of Compatible type No. Deletion of Operating temperatuer range Pin Description Addition of note 1 Block Diagram Addition of note 1 Mode Selection Addition of note 3 Abusolute Maximum Ratings Addition of note 4 Recommended DC operating Condition $V_{IH}$ (min) 2.4 V to 1.9 V Addition of note 4 DC Characteristics $I_{CC3}$ (max): 8/12/20/30 mA to 8/12/15/30 mA AC Characteristics Test condition: Input pulse levels: 0 V to 3.0 V to 0.4 V to 2.4 V ( $V_{CC} \leq 3.6$ V), 0.4 V to 3.0 V ( $V_{CC} >$ 3.6V) Addition of note 2 Read Timing Waveform: Addition of note 1 Write Cycle: $t_{DS}$ (min): 50 ns to 70 ns Addition of note 4, 5 Byte Write Timing Waveform (1) and (2): Addition of note 1 Page Write Timing Waveform (1) and (2): Addition of note 2		

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## HN58V256A Series, HN58V257A Series

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### Revision Record (cont.)

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Rev.	Date	Contents of Modification	Drawn by	Approved by
1.0	Apr. 12, 1995	AC Characteristics Data Polling Timing Waveform: Addition of note 1 Toggle bit Waveform: Addition of note 4 Functional Description Data Protection 2-(2) Addition of figure		

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